

**GENERAL POWER OF ATTORNEY TO PROSECUTE APPLICATIONS BEFORE THE
UNITED STATES PATENT AND TRADEMARK OFFICE**

I hereby appoint:

☒ Practitioners associated with the Customer Number

22850

as attorney(s) or agent(s) to represent the undersigned before the United States Patent and Trademark Office (USPTO) in connection with any and all patent applications assigned only to the undersigned according to the USPTO assignment records or assignment documents attached to this form in accordance with 37 CFR 3.73(b).


Assignee Name and Address:

Sony United Kingdom Limited
The Heights
Brooklands
Weybridge
KT13 0XW
United Kingdom

A statement under 37 CFR 3.73(b) is attached.

SIGNATURE OF ASSIGNEE OF RECORD

The individual whose signature and title is supplied below is authorized to act on behalf of the assignee

Signature		Date: 20 Feb 2006
Name	DERRY NEWMAN	Telephone: +44 1932 816199
Title	MANAGING DIRECTOR	

STATEMENT UNDER 37 CFR 3.73(b)

Applicant/Patent Owner: Daniel TAPSON

Application No./Patent No.: 10/006,298

Filed/Issue Date: December 6, 2001

Entitled: EMBEDDING DATA IN MATERIAL

SONY UNITED KINGDOM LIMITED

(Name of Assignee)

, a CORPORATION

(Type of Assignee, e.g., corporation, partnership, government agency, etc.)

States that it is:

1. ☐ the assignee of the entire right, title, and interest; or
2. ☐ an assignee of less than the entire right, title and interest.

The extent (by, percentage) of its ownership interest is _____ %

in the patent application/patent identified above by virtue of an assignment from the inventor(s) of the patent application/patent identified above. A copy of the assignment is attached. The assignment was previously recorded or is being recorded concurrently herewith.

The undersigned (whose title is supplied below) is authorized to act on behalf of the assignee.

Signature

Date

Bradley D. Lytle

(703)413-3000

Printed or Typed Name

James D. Hamilton

Telephone Number

Registration No. 28,421

40,073

Registration Number

ASSIGNMENT

WHEREAS, I, as below named inventors, residing at the addresses stated next to our names, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in

EMBEDDING DATA IN MATERIAL

for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address;

AND WHEREAS, SONY UNITED KINGDOM LIMITED, a United Kingdom corporation, with offices at The Heights, Brooklands, Weybridge KT13 OXW, England, (hereinafter referred to as ASSIGNEE) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States;

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto;

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEES or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States;


And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense;

And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

And I hereby authorize and request my attorney(s) of record in this application to insert the serial number and filing date of this application in the spaces that follow: Serial Number: , Filing Date:

This assignment executed on the dates indicated below.

Name of first or sole inventor	Execution date of U.S. Patent Application
Daniel Tapson	
Residence of first or sole inventor	
3 Queen Mary Avenue, Basingstoke, Hampshire, RG21 3PL, United Kingdom	
Signature of first or sole inventor	Date of this assignment
	30/11/01
Name of second inventor	Execution date of U.S. Patent Application
Residence of second inventor	
Signature of second inventor	Date of this assignment
Name of third inventor	Execution date of U.S. Patent Application
Residence of third inventor	
Signature of third inventor	Date of this assignment